

## 20V N-Channel Enhancement-Mode MOSFET

### FEATURES

- $R_{DS(ON)} \leq 85m\Omega @ V_{GS}=4.5V$
- $R_{DS(ON)} \leq 115m\Omega @ V_{GS}=2.5V$
- $R_{DS(ON)} \leq 135m\Omega @ V_{GS}=1.8V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

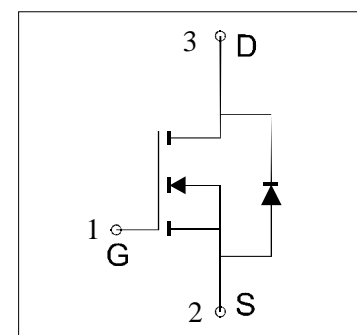
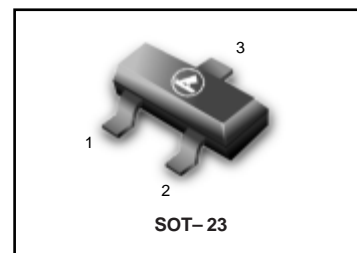
### APPLICATIONS

- Power Management in Notebook
- Portable Equipment
- Load Switch
- DSC

### Ordering Information

Device	Marking	Shipping
LN2302BLT1G S-LN2302BLT1G	02B	3000/Tape&Reel
LN2302BLT3G S-LN2302BLT3G	02B	10000/Tape&Reel

LN2302BLT1G  
S-LN2302BLT1G



### Absolute Maximum Ratings ( $T_A=25^\circ C$ Unless Otherwise Noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	$\pm 8$	V
Continuous Drain Current( $t_J=150^\circ C$ )	$I_D$	$T_A=25^\circ C$	2.8
		$T_A=70^\circ C$	2.2
Pulsed Drain Current	$I_{DM}$	10	A
Maximum Body-Diode Continuous Current	$I_S$	1.6	A
Maximum Power Dissipation	$P_D$	$T_A=25^\circ C$	1.25
		$T_A=70^\circ C$	0.8
Operating Junction Temperature	$T_J$	150	$^\circ C$
Maximum Junction-to-Ambient	$R_{thJA}$	$T \leq 10$ sec	77
		Steady State	105
Thermal Resistance-Junction to Case	$R_{\theta JC}$	70	$^\circ C/W$

\*The device mounted on  $1in^2$  FR4 board with 2 oz copper

## LN2302BLT1G , S-LN2302BLT1G

## ELECTRICAL CHARACTERISTICS

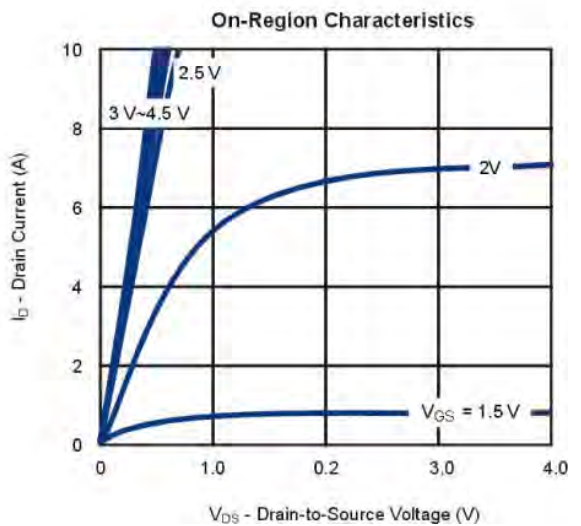
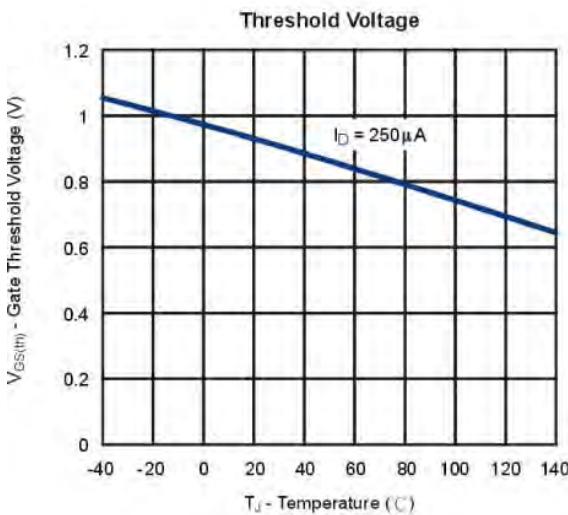
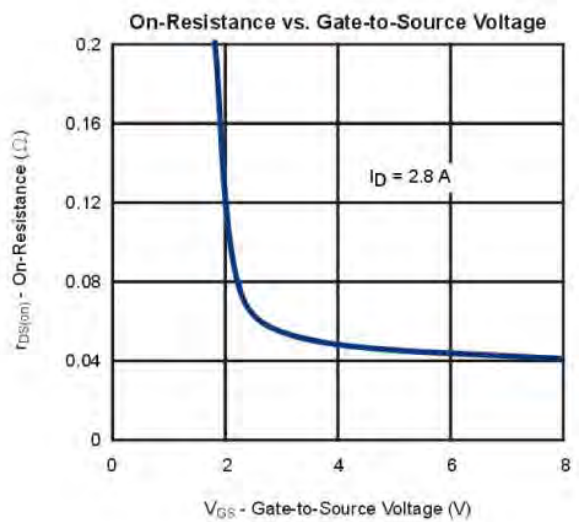
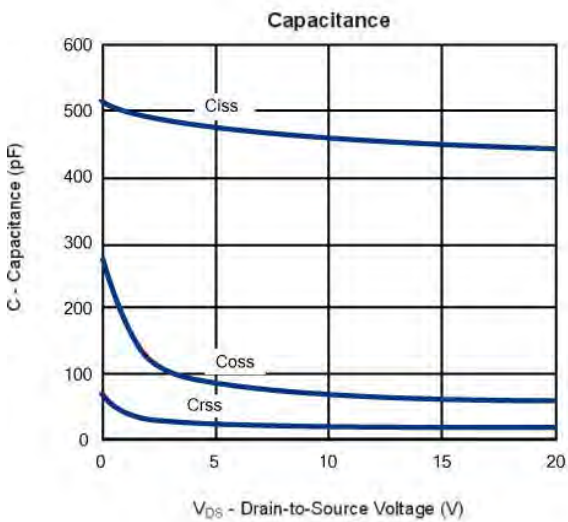
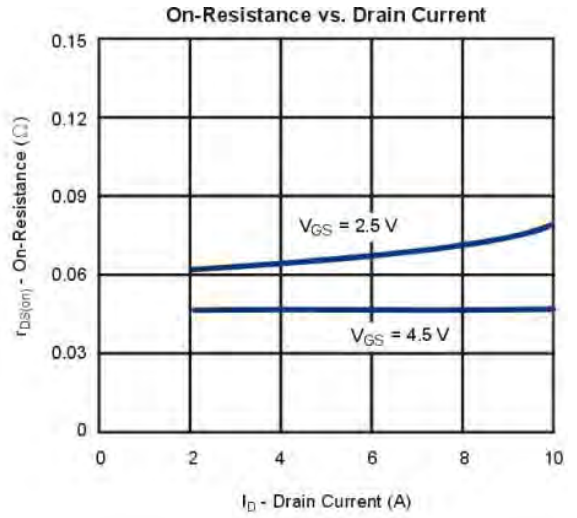
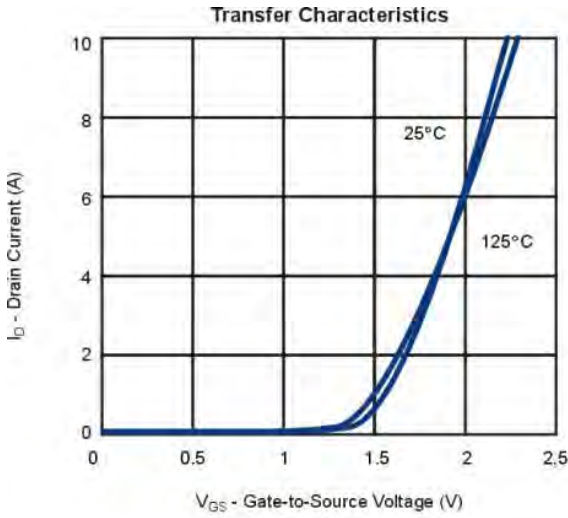
Symbol	Parameter	Limit	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.75	1.0	
$I_{GSS}$	Gate-Body Leakage Current	$V_{DS}=0V, V_{GS}=\pm 8V$			$\pm 100$	nA
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=20V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=20V, V_{GS}=0V$ $T_J=55^\circ C$			10	
$I_{D(ON)}$	On-State Drain Current <sup>a</sup>	$V_{DS}\geq 5V, V_{GS}= 4.5V$	6			A
		$V_{DS}\geq 5V, V_{GS}= 2.5V$	4			
$R_{DS(ON)}$	Drain-Source On-Resistance	$V_{GS}=4.5V, I_D= 2.8A$		55	85	m $\Omega$
		$V_{GS}=2.5V, I_D= 2.5A$		65	115	
		$V_{GS}=1.8V, I_D= 2.2A$		80	130	
$V_{SD}$	Diode Forward Voltage	$I_S=1A, V_{GS}=0V$		0.75	1.2	V
<b>DYNAMIC PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{DS}=10V, V_{GS}=4.5V, I_D=2.8A$		9		nC
$Q_{gs}$	Gate-Source Charge			2.2		
$Q_{gd}$	Gate-Drain Charge			3		
$C_{iss}$	Input Capacitance	$V_{DS}=10V, V_{GS}=0V, f=1MHz$		450		pF
$C_{oss}$	Output Capacitance			72		
$C_{rss}$	Reverse Transfer Capacitance			22		
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=10V, R_L=10\Omega$ $V_{GEN}=4.5\Omega, R_G=6\Omega$		9		ns
$t_r$	Rise Time			23		
$t_{d(off)}$	Turn-Off Delay Time			38		
$t_f$	Fall Time			3		

Notes:

 a. Pulse test; pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$

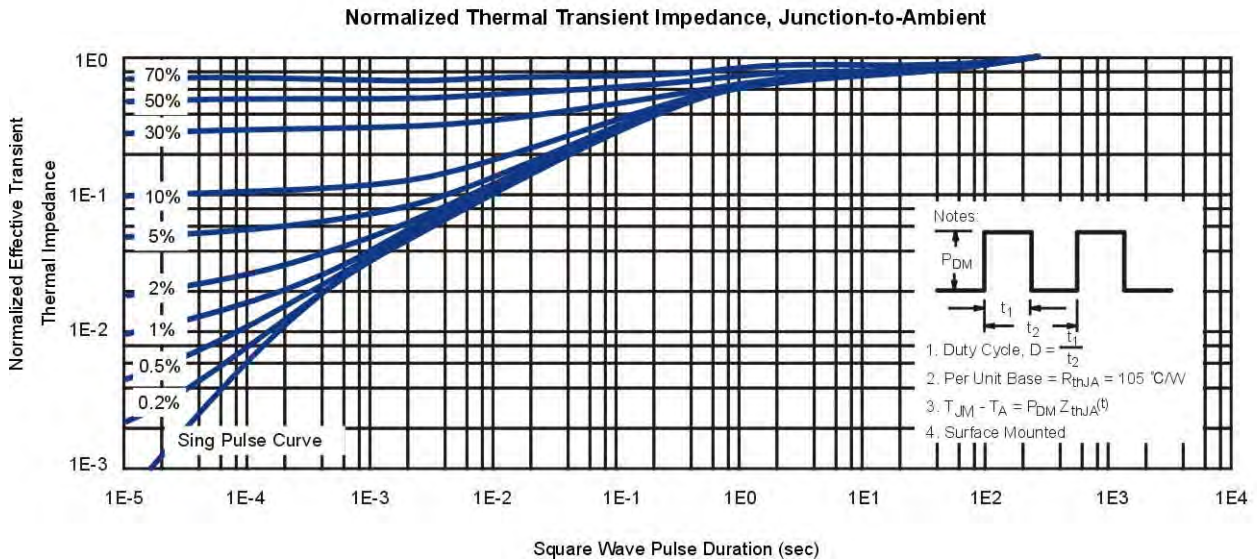
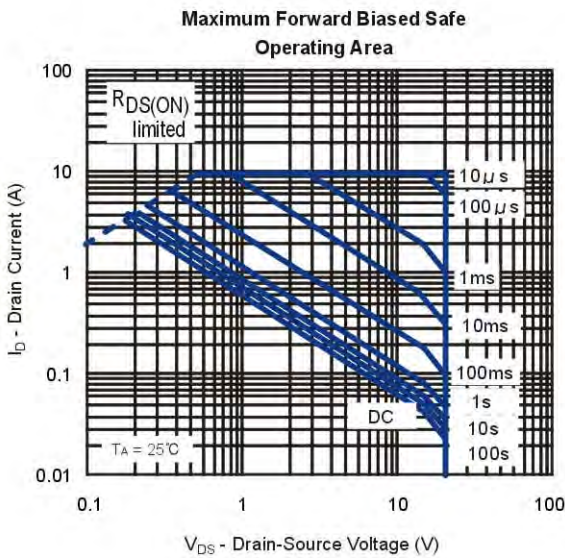
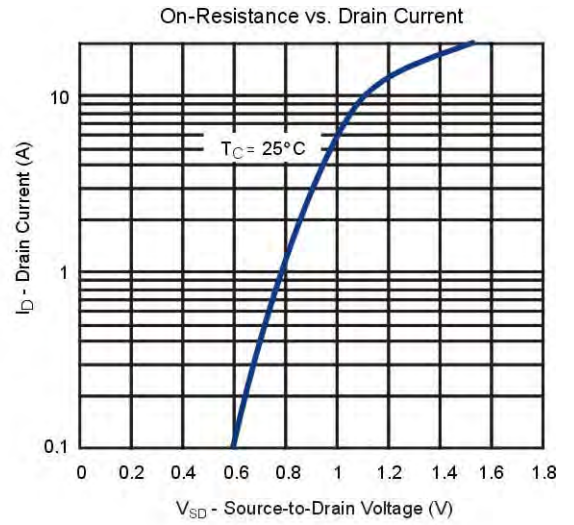
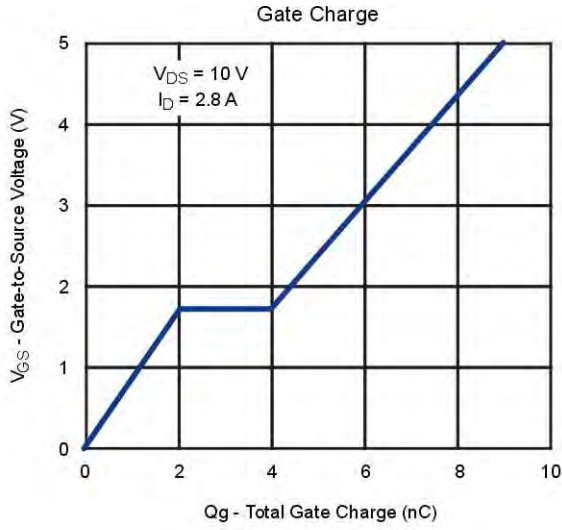
Typical Characteristics (T<sub>J</sub> =25°C Noted)

LN2302BLT1G , S-LN2302BLT1G



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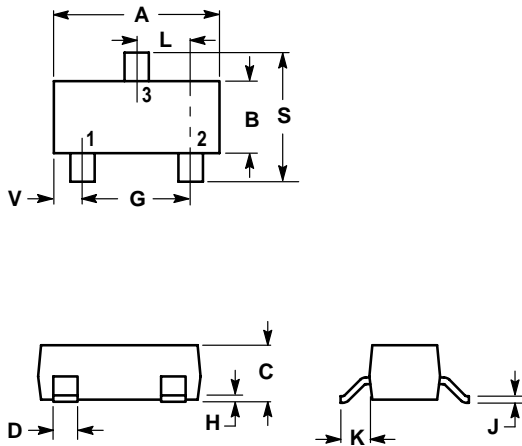


LN2302BLT1G , S-LN2302BLT1G

SOT-23

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

